

TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TD62501P,TD62501F,TD62502P,TD62502F,TD62503P,TD62503F,TD62504P
TD62504F,TD62505P,TD62505F,TD62506P,TD62506F,TD62507P,TD62507F

7CH SINGLE DRIVER

TD62501, 502, 503, 504P / F : COMMON EMITTER

TD62505, 506P / F : COMMON COLLECTOR

TD62507P / F : ISOLATED

The TD62501P / F Series are comprised of seven or five NPN Transistor Arrays.

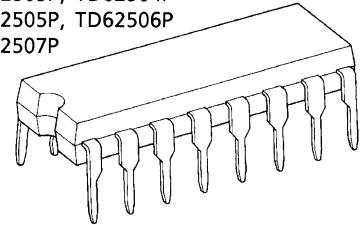
For proper operation, the substrate (SUB) must be connected to the most negative voltage.

Applications include relay, hammer, Lamp and display (LED) drivers.

FEATURES

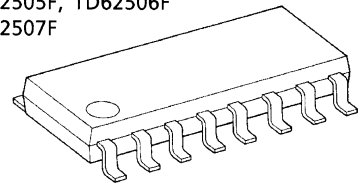
- Output Current (Single Output) 200 mA MAX.
- High Sustaining Voltage Output 35 V MIN.
- Inputs Compatible with Various Types of Logic.
- TD62501P / F, TD62505P / F and TD62507P / F: Using external resistor...General Purpose
- TD62502P / F
: $R_{IN} = 10.5 \text{ k}\Omega + 7\text{V Zener Diode}$...14~25 V P-MOS
- TD62503P / F, TD62506P / F
: $R_{IN} = 2.7 \text{ k}\Omega$...TTL, 5 V C-MOS
- TD62504P / F, : $R_{IN} = 10.5 \text{ k}\Omega$...6~15 V P-MOS, C-MOS
- Package Type-P : DIP-16 pin
- Package Type-F : SOP-16 pin

TD62501P, TD62502P
 TD62503P, TD62504P
 TD62505P, TD62506P
 TD62507P



DIP16-P-300-2.54A

TD62501F, TD62502F
 TD62503F, TD62504F
 TD62505F, TD62506F
 TD62507F



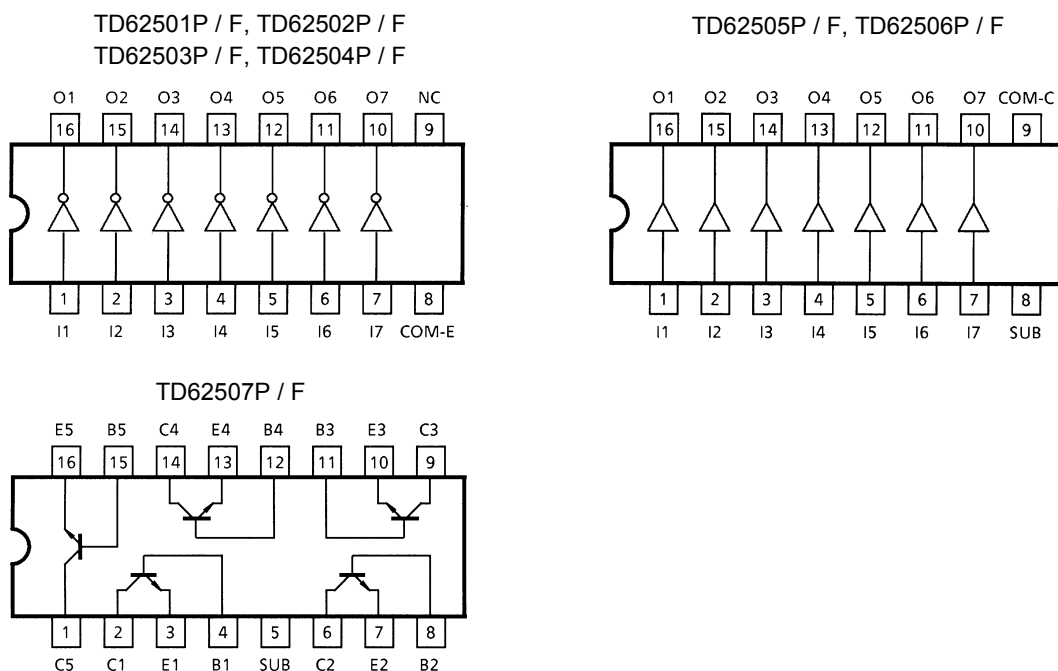
SOP16-P-225-1.27

Weight

DIP16-P-300-2.54A : 1.11 g (Typ.)

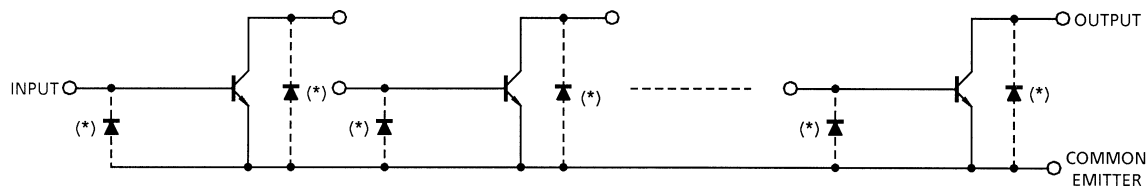
SOP16-P-225-1.27 : 0.16 g (Typ.)

PIN CONNECTION (Top view)

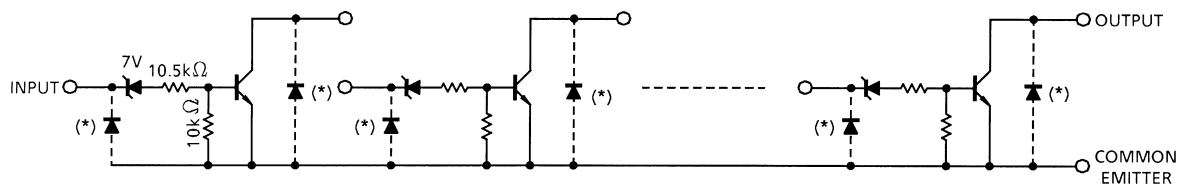


SCHEMATICS (Each driver)

TD62501P / F

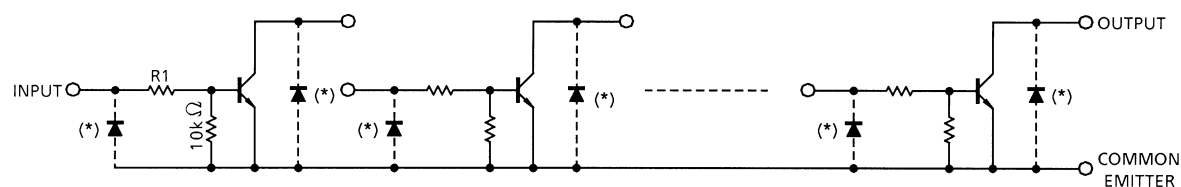


TD62502P / F



TD62503P / F

TD62504P / F

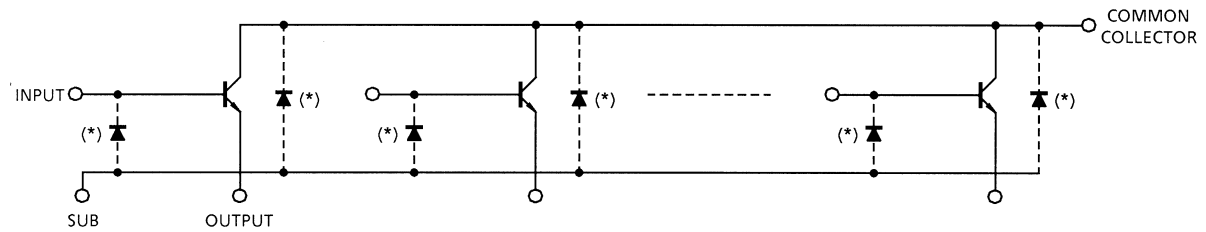


TD62503P / F $R1 = 2.7 \text{ k}\Omega$, TD62504P / F $R1 = 10.5 \text{ k}\Omega$

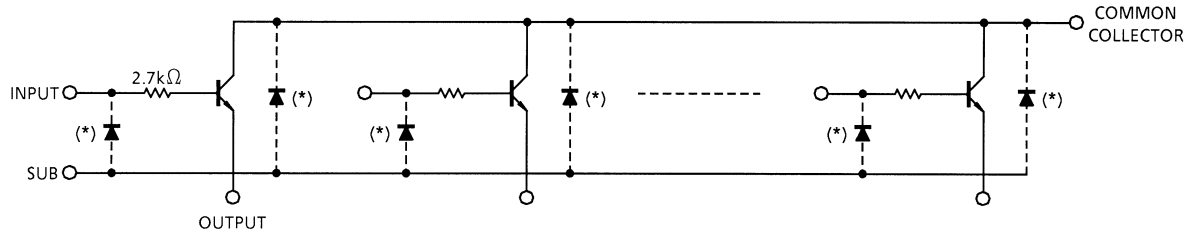
*: Parasitic Diodes

SCHEMATICS (Each driver)

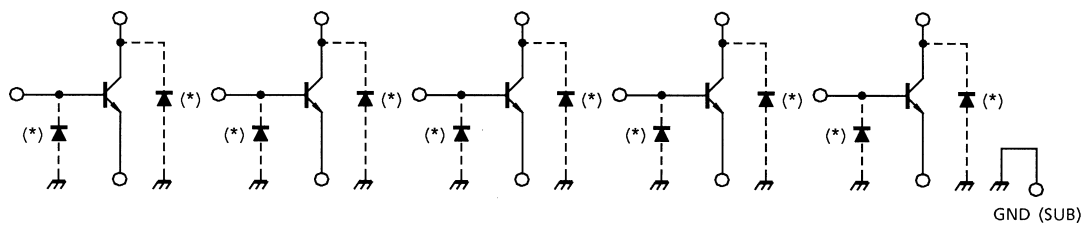
TD62505P / F



TD62506P / F



TD62507P / F



*: Parasitic Diodes

Note: The input and output parasitic diodes cannot be used as clamp diodes.

MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

| CHARACTERISTIC | | SYMBOL | RATING | UNIT |
|---------------------------|---|----------------------|----------------|---------|
| Collector-Emitter Voltage | | V_{CEO} | 35 | V |
| Collector-Base Voltage | | V_{CBO} | 50 | V |
| Collector Current | | I_C | 200 | mA / ch |
| Input Voltage | | V_{IN} (Note 1) | -0.5~45 | V |
| | | V_{IN} (Note 2) | -0.5~30 | |
| Input Current | | I_{IN} (Note 3) | 25 | mA |
| Isolation Voltage | | V_{SUB} | 35 | V |
| Power Dissipation | P | P_D | 1.0 | W |
| | F | | 0.625 (Note 4) | |
| Operating Temperature | | T_{opr} | -40~85 | °C |
| Storage Temperature | | T_{stg} | -55~150 | °C |

Note 1: TD62506P / F

Note 2: TD62502P / F, TD62503P / F, TD62504P / F

Note 3: TD62501P / F, TD62505P / F, TD62507P / F

Note 4: On Glass Epoxy PCB (30 × 30 × 1.6 mm, Cu 50%)

RECOMMENDED OPERATING CONDITIONS (Ta = -40~85°C)

| CHARACTERISTIC | | SYMBOL | CONDITION | MIN | TYP. | MAX | UNIT |
|---------------------------|--------------|-----------|---------------|-----|------|-------|---------|
| Collector-Emitter Voltage | | V_{CEO} | | 0 | — | 35 | V |
| Collector-Base Voltage | | V_{CBO} | | 0 | — | 50 | V |
| Collector Current | | I_C | | 0 | — | 150 | mA / ch |
| Input Voltage | TD62506P / F | V_{IN} | | 0 | — | 35 | V |
| | TD62502P / F | | | | | | |
| | TD62503P / F | | | 0 | — | 25 | |
| | TD62504P / F | | | | | | |
| Input Current | TD62501P / F | I_{IN} | | 0 | — | 10 | mA |
| | TD62505P / F | | | | | | |
| | TD62507P / F | | | | | | |
| Power Dissipation | P | P_D | | — | — | 0.360 | W |
| | F | | On PCB (Note) | — | — | 0.325 | |

Note: 30 × 30 × 1.6 mm, Cu 50%

ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

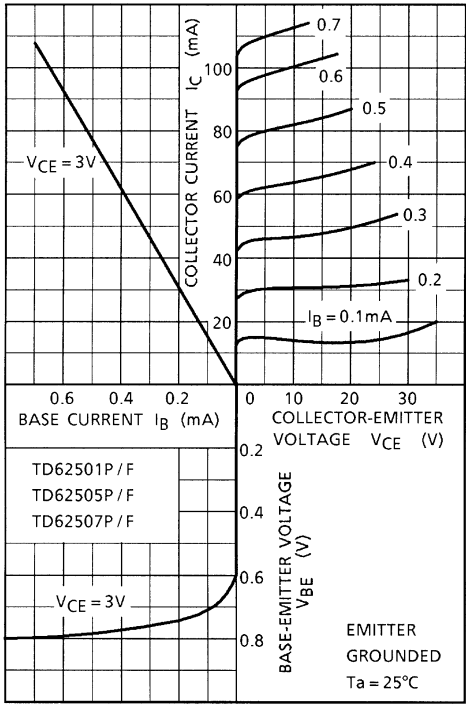
| CHARACTERISTIC | | SYMBOL | TEST CIR-CUIT | TEST CONDITION | MIN | TYP. | MAX | UNIT |
|--------------------------------------|--------------|---------------|---------------|---|-----|------|-----|------|
| Output Leakage Current | | I_{CEX} | 1 | $V_{CE} = 25\text{ V}, V_{IN} = 0$ | — | — | 10 | μA |
| Collector-Emitter Saturation Voltage | | $V_{CE(sat)}$ | 2 | $I_{IN} = 1\text{ mA}, I_C = 10\text{ mA}$ | — | — | 0.2 | V |
| | | | | $I_{IN} = 3\text{ mA}, I_C = 150\text{ mA}$ (Note 1) | — | — | 0.8 | |
| DCCurrent Transfer Ratio | (Note 2) | h_{FE} | 2 | $V_{CE} = 10\text{ V}, I_C = 10\text{ mA}$ | 70 | — | — | |
| | (Note 3) | | | | 50 | — | — | |
| Input Voltage | TD62502P / F | $V_{IN(ON)}$ | 3 | $I_{IN} = 1\text{ mA}$ $I_C = 10\text{ mA}$ | 13 | 17 | 23 | V |
| | TD62503P / F | | | | 2.4 | 3.4 | 4.2 | |
| | TD62504P / F | | | | 7.5 | 11.5 | 15 | |
| Turn-On Delay | | t_{ON} | 4 | $V_{OUT} = 35\text{ V}, R_L = 3.3\text{ k}\Omega$ $C_L = 15\text{ pF}$ | — | 50 | — | ns |
| Turn-Off Delay | | t_{OFF} | | | — | 200 | — | |

Note 1: Except TD62502P / F Only

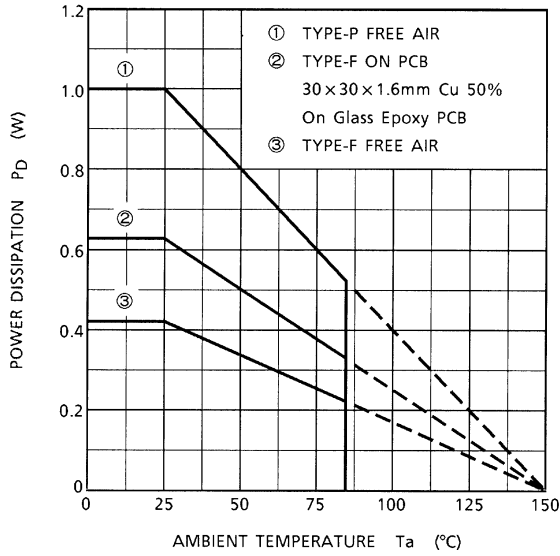
Note 2: Only TD62501P / F, TD62505P / F, TD62506P / F, TD62507P / F

Note 3: Only TD62502P / F, TD62503P / F, TD62504P / F

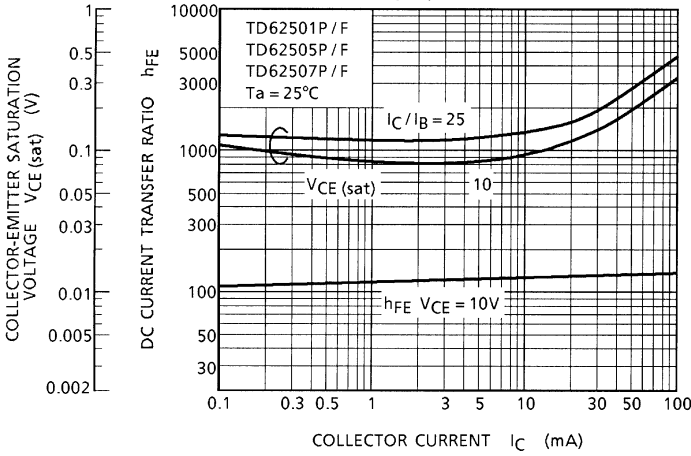
STATIC CHARACTERISTICS

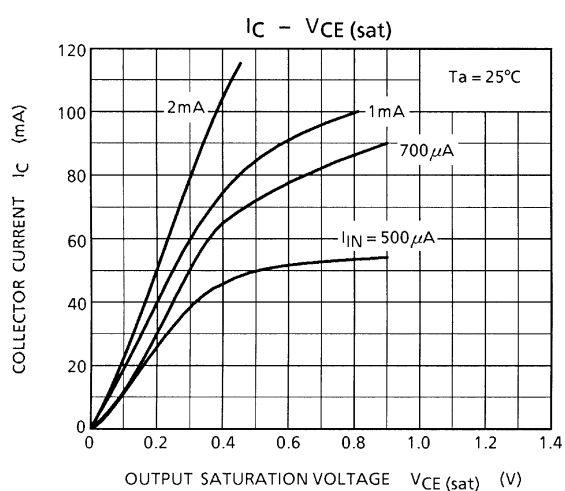
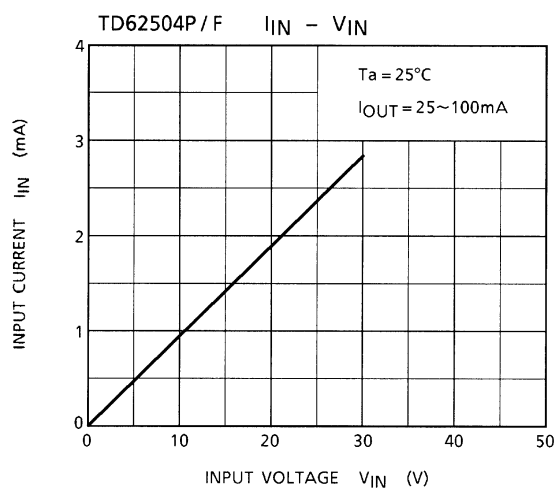
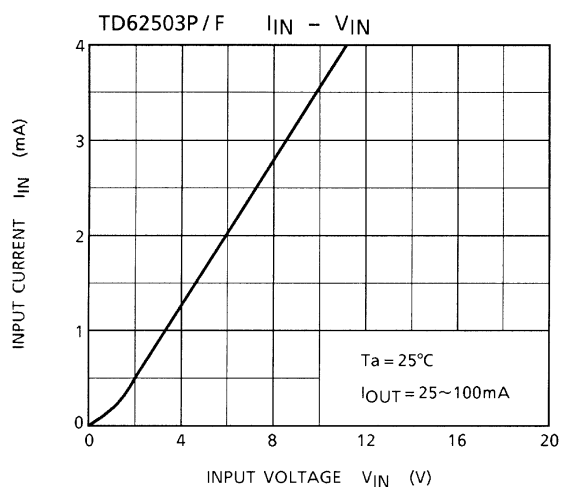
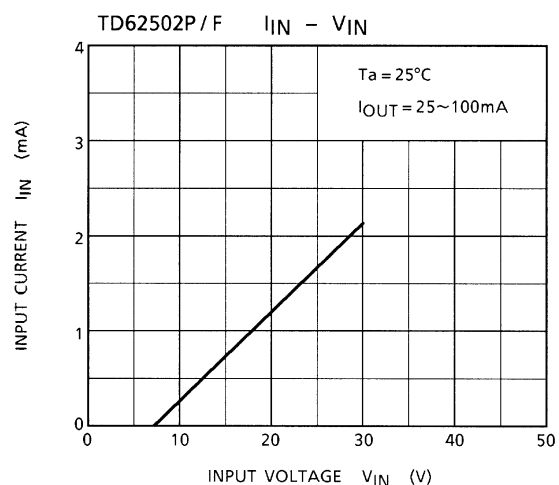
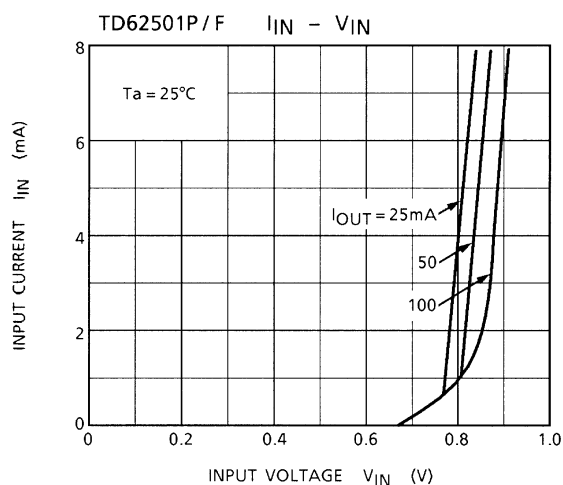


$P_D - T_a$



$V_{CE} (sat), h_{FE} - I_C$

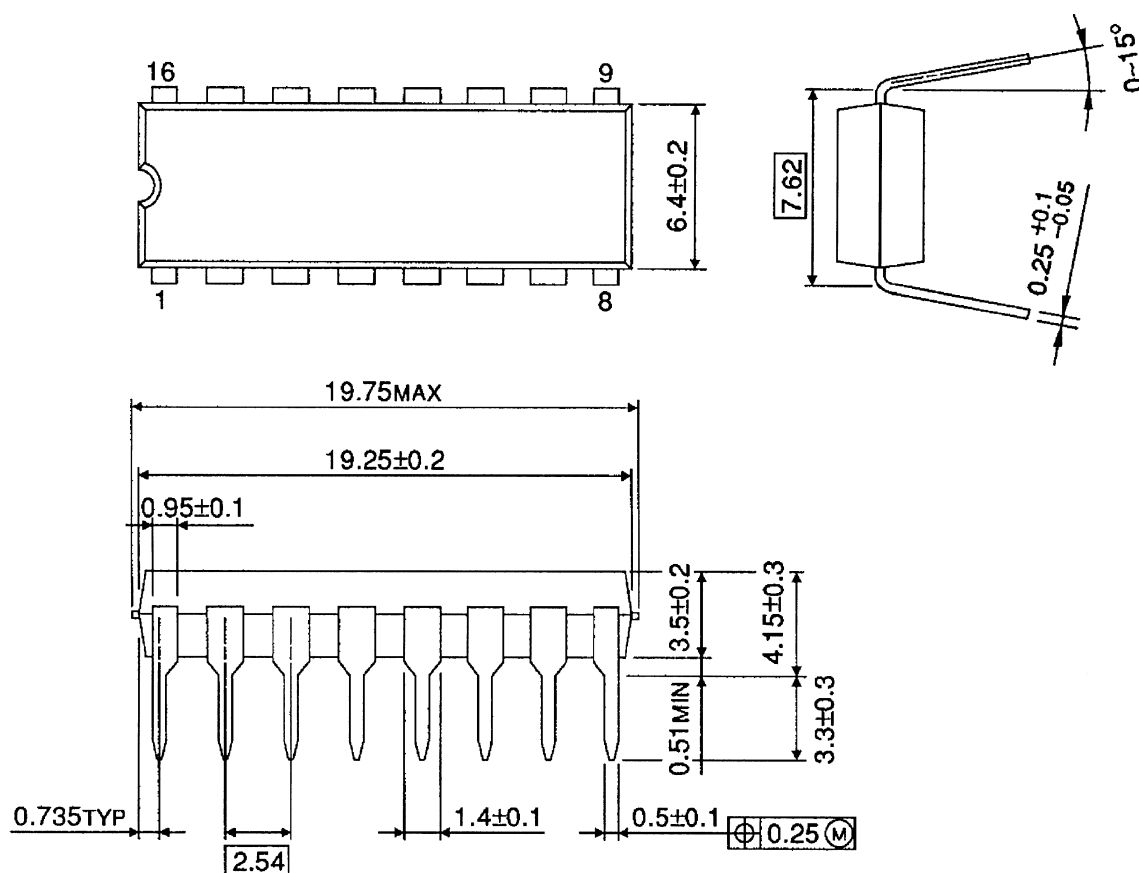




PACKAGE DIMENSIONS

DIP16-P-300-2.54A

Unit: mm

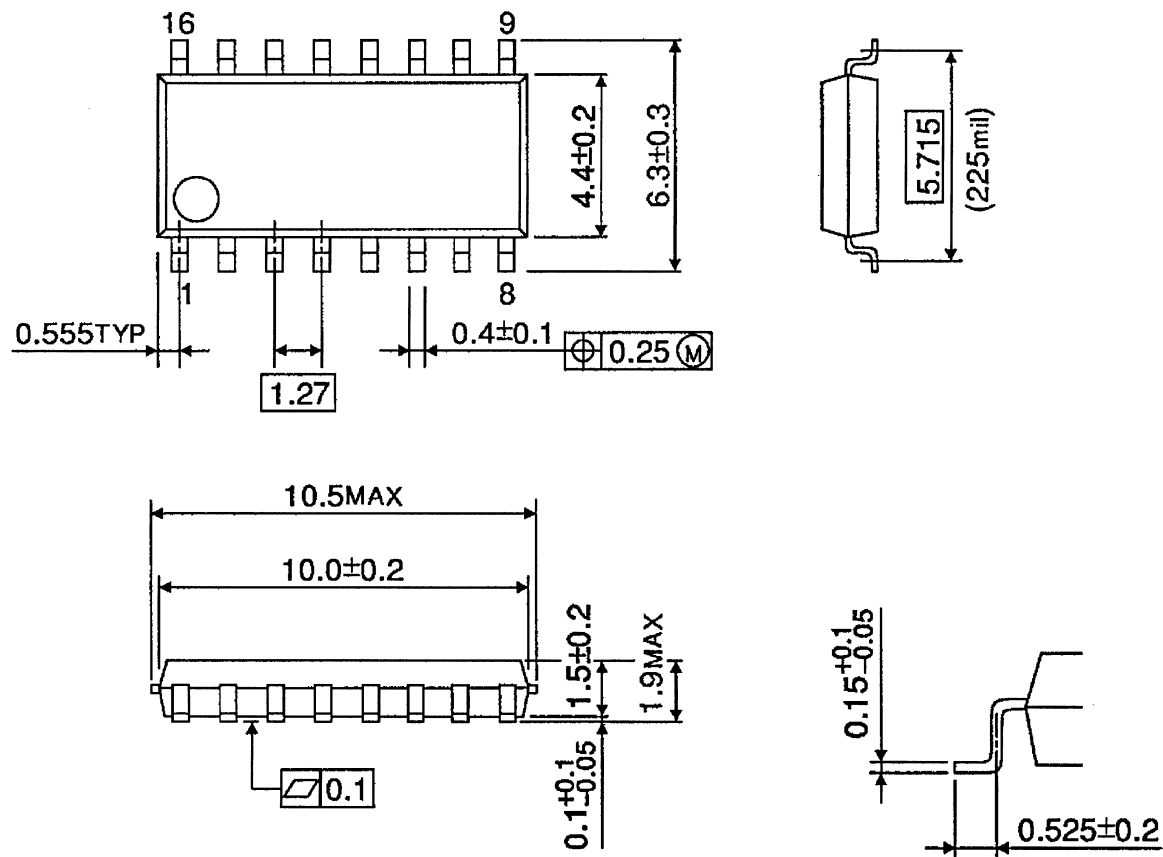


Weight: 1.11 g (Typ.)

PACKAGE DIMENSIONS

SOP16-P-225-1.27

Unit: mm



Weight: 0.16 g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

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